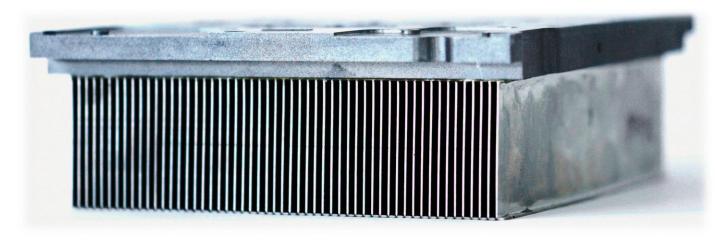
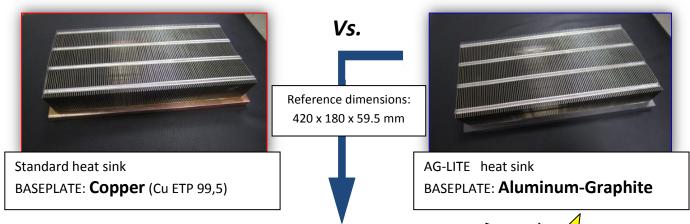


PATENT PENDING





Heat sink weight reduction = 61%

- Excellent Heat spreading (baseplate x-y Thermal conductivity = 235 W/mK)
- Direct metal joint between fins and baseplate (no additional thermal interface)
- High machinability (threaded holes, complex milling and drilling patterns...)
- Surface plating available

